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(12) United States Design Patent

Frost et al.

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(54) **SOLID-STATE MEMORY MODULE**

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(**) Term: **14 Years**

(21) Appl. No.: **29/389,135**

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(51) **LOC (9) Cl.** **14-02**
(52) **U.S. Cl.** **D14/313**
(58) **Field of Classification Search** D14/300–313, D14/348–356; 312/223.2; 361/679.39, 690, 361/695, 724–730, 796
See application file for complete search history.

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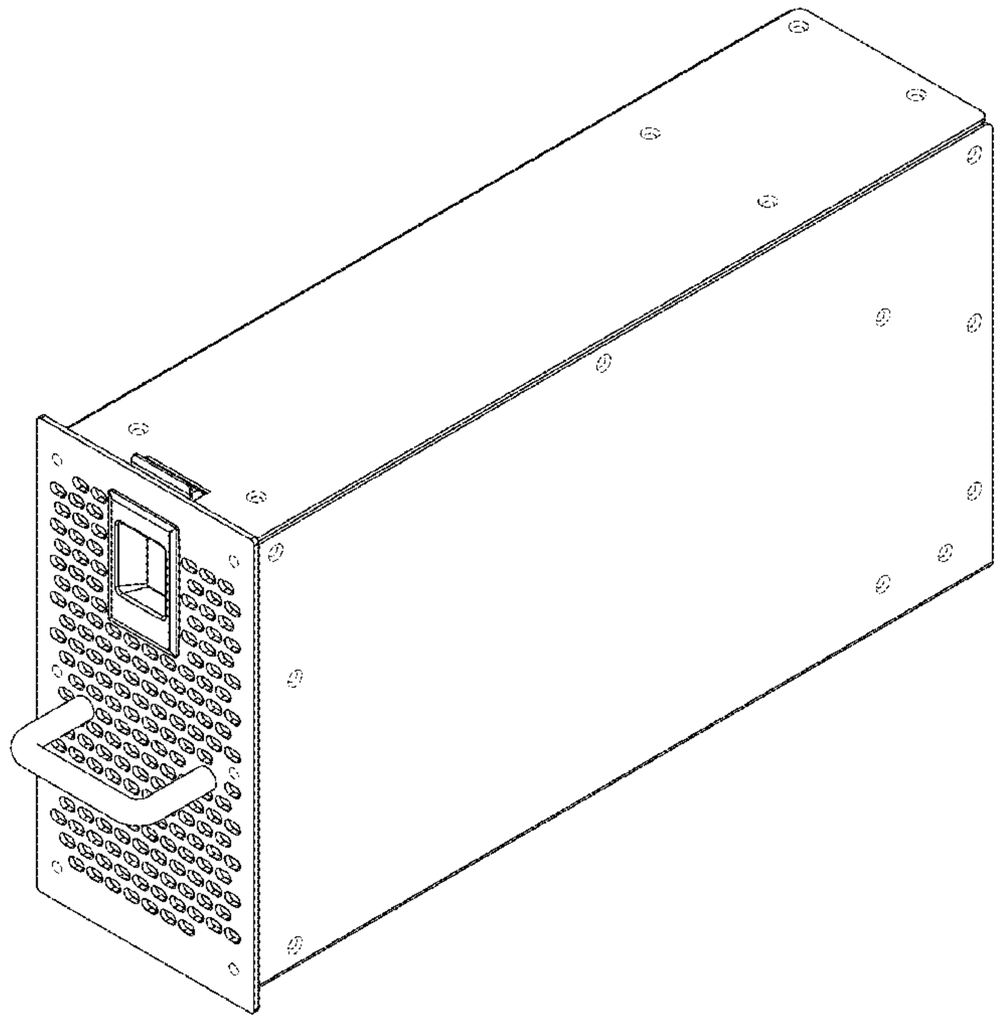
(57) **CLAIM**

The ornamental design for a solid-state memory module, as shown and described.

DESCRIPTION

FIG. **1** is a perspective view of a solid-state memory module according to my new design;
FIG. **2** is a top view of the solid-state memory module according to my new design;
FIG. **3** is a bottom view of the solid-state memory module according to my new design;
FIG. **4** is a front view of the solid-state memory module according to my new design;
FIG. **5** is a rear view of the solid-state memory module according to my new design; and,
FIG. **6** is a left side view of the solid-state memory module according to my new design, the right side being a mirror image thereof.
The portions of the solid-state memory module shown in broken lines form no part of the claimed design.

1 Claim, 4 Drawing Sheets



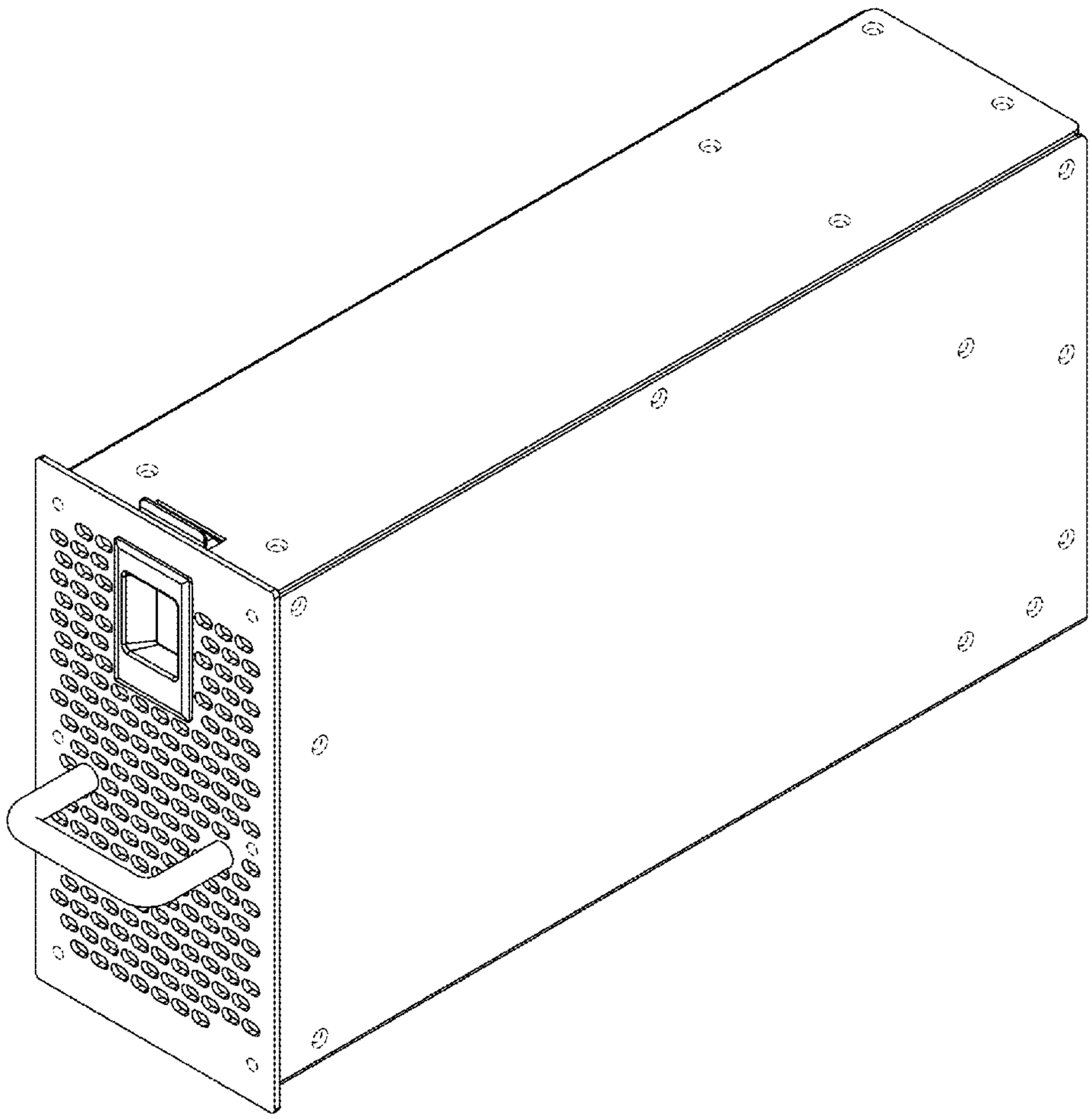


FIG. 1

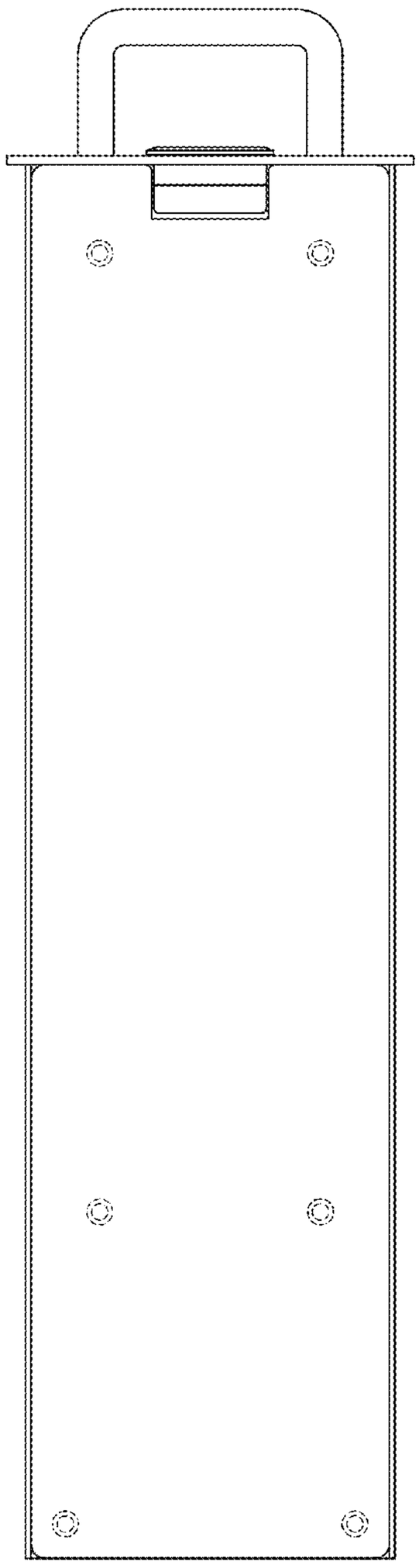


FIG. 2

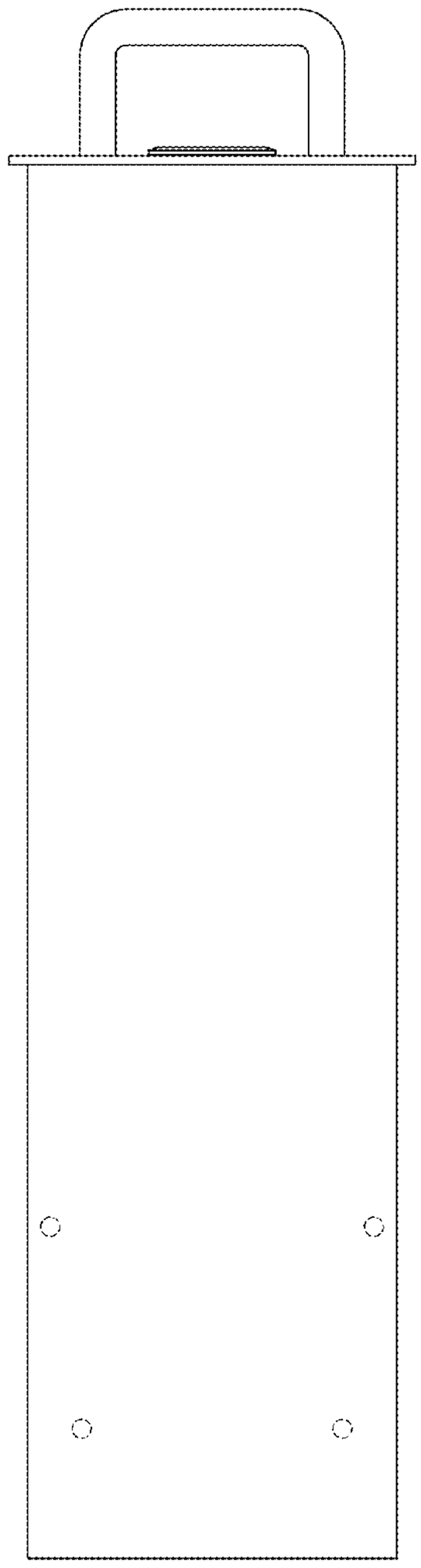


FIG. 3

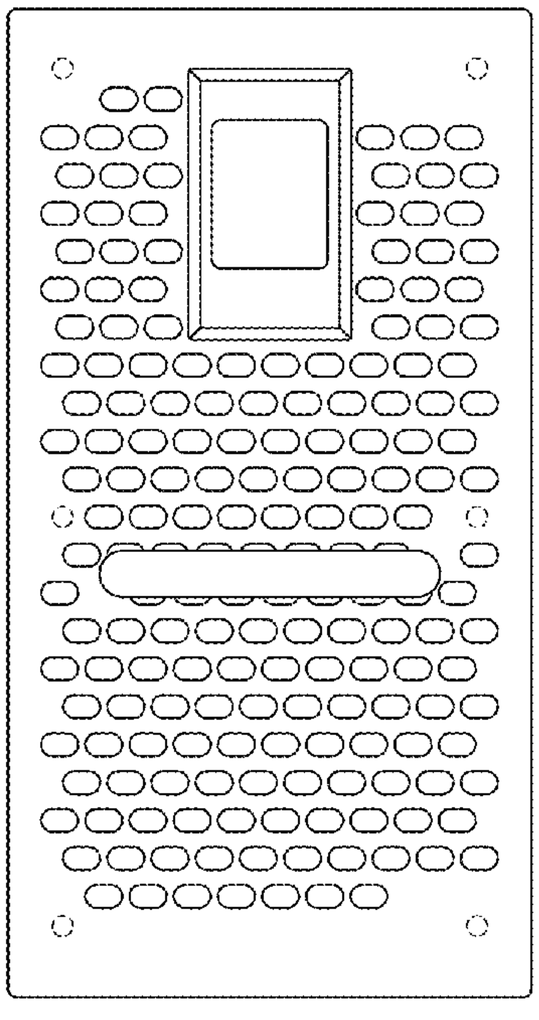


FIG. 4

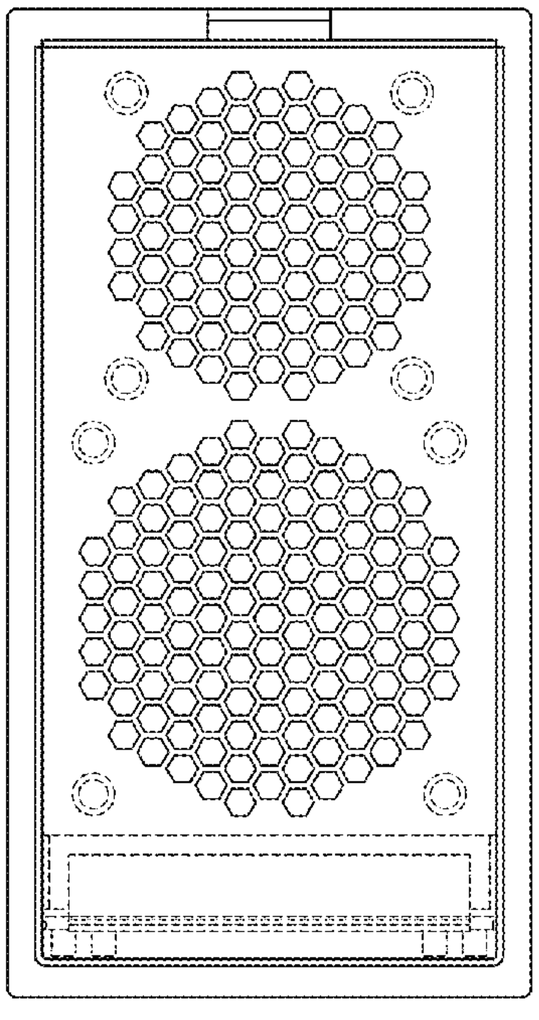


FIG. 5

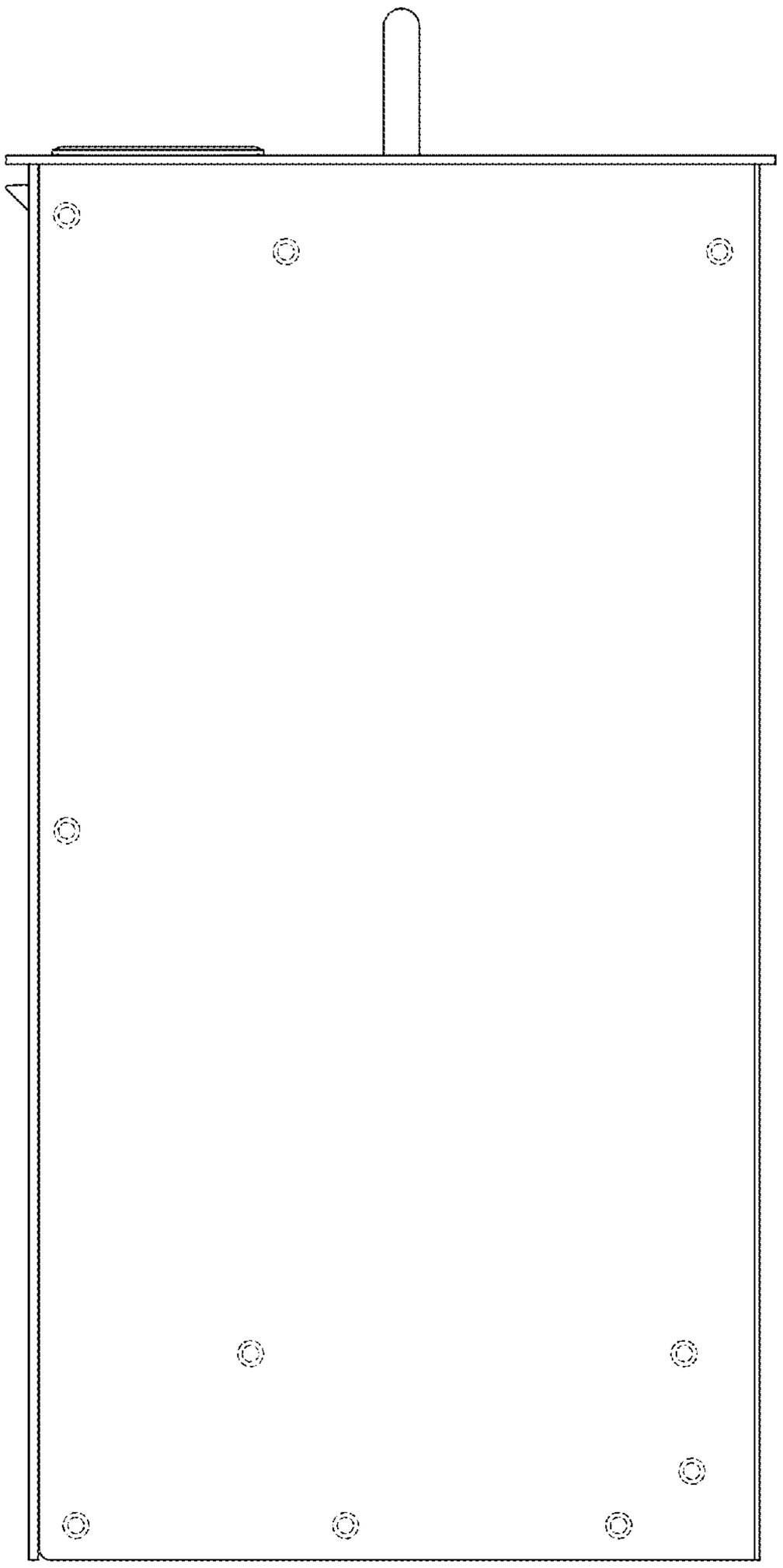


FIG. 6